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Si7462DP

RoHS COMPLIANT

HALOGEN FREE

Vishay Siliconix



PRODUCT SUMMARY V_{DS} (V) 200 $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V 0.130 $R_{DS(on)}$ max. (Ω) at V_{GS} = 6 V 0.142 Qg typ. (nC) 20 I_D (A) 4.1 Single Configuration

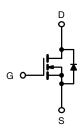
FEATURES

N-Channel 200 V (D-S) MOSFET

- TrenchFET[®] power MOSFETs
- New low thermal resistance PowerPAK® package with low 1.07 mm profile
- PWM optimized for fast switching

APPLICATIONS

· Primary side switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free	Si7462DP-T1-E3
Lead (Pb)-free and halogen-free	Si7462DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (Γ _A = 25 °C, unl	ess otherwise	noted)			
PARAMETER		SYMBOL	10 s	STEADY STATE	UNIT	
Drain-source voltage		V _{DS}	200	200	N	
Gate-source voltage		V _{GS}	± 20	± 20	V	
Continuous drain current (T _J = 150 °C) ^a	T _A = 25 °C		4.1	2.6		
	T _A = 85 °C	l _D	3	1.9		
Pulsed drain current	sed drain current		12	12	A	
Avalanche current	L = 0.1 mH	I _{AS}	6	6		
Single avalanche energy (duty cycle \leq 1 %)		E _{AS}	1.8	1.8	mJ	
Continuous source current (diode conduction) a		I _S	4	1.6	А	
Maximum power dissipation ^a	T _A = 25 °C	D	4.8	1.9	W	
	T _A = 85 °C	P _D	2.6	1	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		°C	
Soldering recommendations (peak temperature) b, c		Ŭ	260			

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction to ambient a	t ≤ 10 s	P	21	26	
Maximum junction-to-ambient ^a	Steady state	R _{thJA}	55	65	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.7	2.1	

Notes

a. Surface mounted on 1" x 1" FR4 board

See solder profile (www.vishav.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper b. (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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SPECIFICATIONS ($T_J = 25$	°C, unless o	otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	<u>.</u>						
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V	
Gate-body leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	IDSS	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 85 $^{\circ}C$	-	-	20	μΑ	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	12	-	-	А	
Drain-source on-state resistance a	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.1 \text{ A}$	-	0.110	0.130	0	
	R _{DS(on)}	$V_{GS} = 6 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	-	0.120	0.142	V nA µA	
Forward transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 4.1 \text{ A}$	-	13	-	S	
Diode forward voltage ^a	V _{SD}	$I_{S} = 4 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Dynamic ^b							
Total gate charge	Qg		-	20	30		
Gate-source charge	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 4.1 A	-	4.5	-	nC	
Gate-drain charge	Q _{gd}		-	6.5	-		
Gate resistance	Rg		-	2	-	Ω	
Turn-on delay time	t _{d(on)}		-	15	25		
Rise time	t _r	$V_{DD} = 100 \text{ V}, \text{ R}_{\text{I}} = 100 \Omega$	-	15	25		
Turn-off delay time	t _{d(off)}	$I_D \cong \overline{1} A$, $V_{GEN} = 10 V$, $R_g = 6 \Omega$	-	40	60	ns	
Fall time	t _f		-	20	30		
Source-drain reverse recovery time	t _{rr}	I _F = 4 A, di/dt = 100 A/μs	-	70	110		

Notes

a. Pulse test: pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

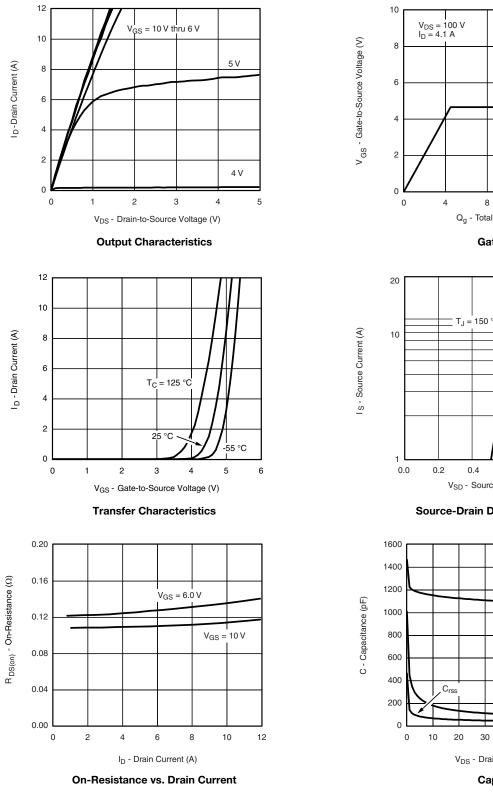
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

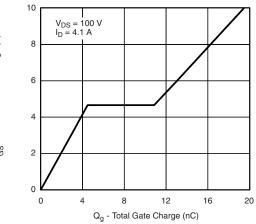
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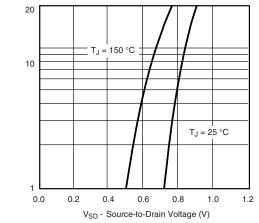
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

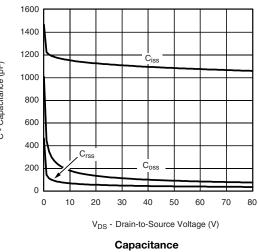




Gate Charge



Source-Drain Diode Forward Voltage



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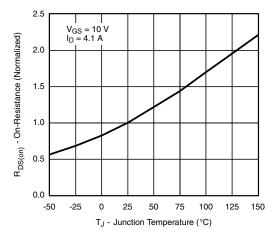
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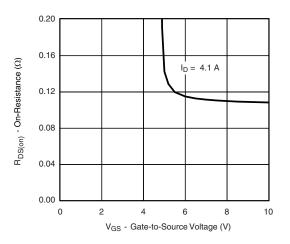
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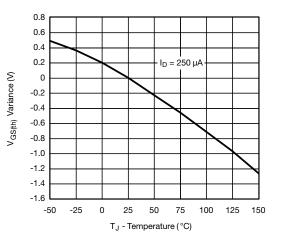
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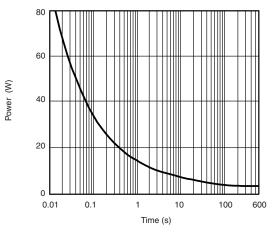
On-Resistance vs. Junction Temperature



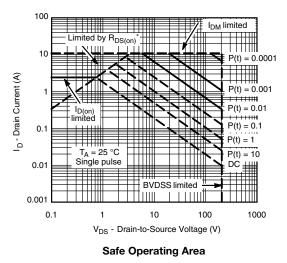
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage







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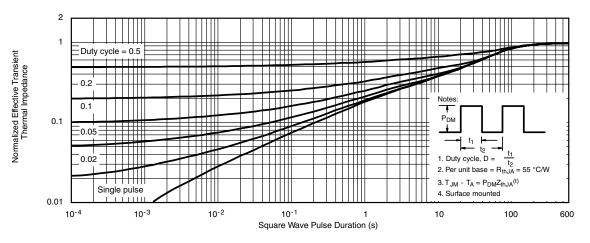
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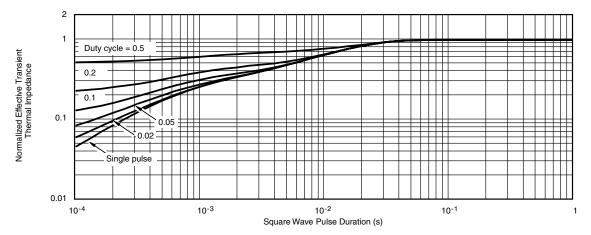


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72136.

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D2

E3

Backside View of Dual Pad



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PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.			0.0225 typ.			
D5		3.98 typ.			0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.236		
E2	3.48	3.66	3.84	0.137	0.144	0.151		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC			0.050 BSC			
К		1.27 typ.		0.050 typ.				
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ.			0.005 typ.			

Revison: 13-Feb-17

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Document Number: 71655

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Application Note 826

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RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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